

## GaAs Hall Element

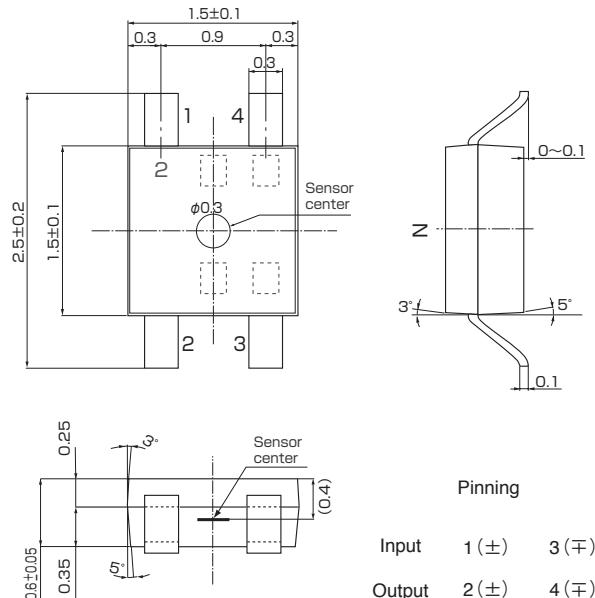
### Absolute Maximum Ratings

Item	Symbol	Conditions	Limit	Unit
Max. Input Voltage	V <sub>C</sub>	Ta=25°C	8	V
Max. Input Power	P <sub>D</sub>		150	mW
Operating Temp. Range	T <sub>OPR</sub>		-40 ~ +125	°C
Storage Temp. Range	T <sub>STG</sub>		-40 ~ +130	°C

SSOT-4



### Dimensional Drawing (Unit : mm)



### Electrical Characteristics(Ta=25°C)

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Output Hall Voltage	V <sub>H</sub> <sup>*</sup>	B=50mT, V <sub>C</sub> =6V	55		75	mV
Input Resistance	R <sub>IN</sub>	B=0mT, I <sub>C</sub> =0.1mA	650		850	Ω
Output Resistance	R <sub>OUT</sub>	B=0mT, I <sub>C</sub> =0.1mA	650		850	Ω
Offset Voltage	V <sub>OS</sub> (V <sub>U</sub> )	B=0mT, V <sub>C</sub> =6V	-11		+11	mV
Temp. Coefficient of V <sub>H</sub>	αV <sub>H</sub> <sup>*</sup>	B=50mT, I <sub>C</sub> =5mA Ta=25~125°C			-0.06	%/C
Temp. Coefficient of R <sub>IN</sub>	αR <sub>IN</sub> <sup>*</sup>	B=0mT, I <sub>C</sub> =0.1mA Ta=25~125°C			0.3	%/C
Linearity	ΔK <sup>*</sup>	B=0.1/0.5T, I <sub>C</sub> =5mA			2	%

Notes : 1. V<sub>H</sub> = VHM - V<sub>OS</sub>(V<sub>U</sub>) (VHM:meter indication)

$$2. \alpha V_H = \frac{1}{V_H(T_1)} \times \frac{V_H(T_2) - V_H(T_1)}{(T_2 - T_1)} \times 100$$

$$3. \alpha R_{IN} = \frac{1}{R_{IN}(T_1)} \times \frac{R_{IN}(T_2) - R_{IN}(T_1)}{(T_2 - T_1)} \times 100$$

$$4. \Delta K = \frac{K(B_1) - K(B_2)}{[K(B_1) + K(B_2)]/2} \times 100$$

T<sub>1</sub> = 25°C, T<sub>2</sub> = 125°C

$$K = \frac{V_H}{I_C \cdot B}$$

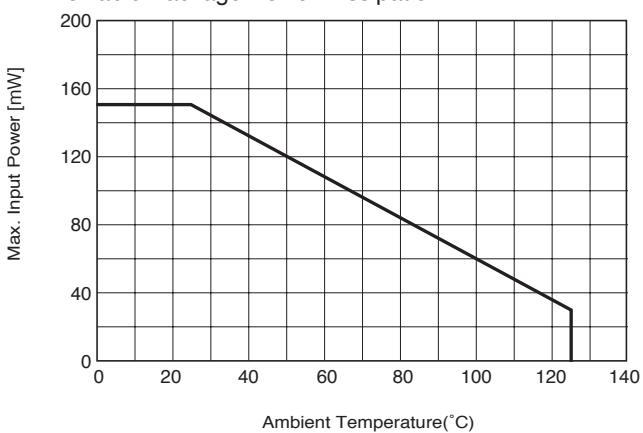
B<sub>1</sub> = 0.5T, B<sub>2</sub> = 0.1T

### Taping

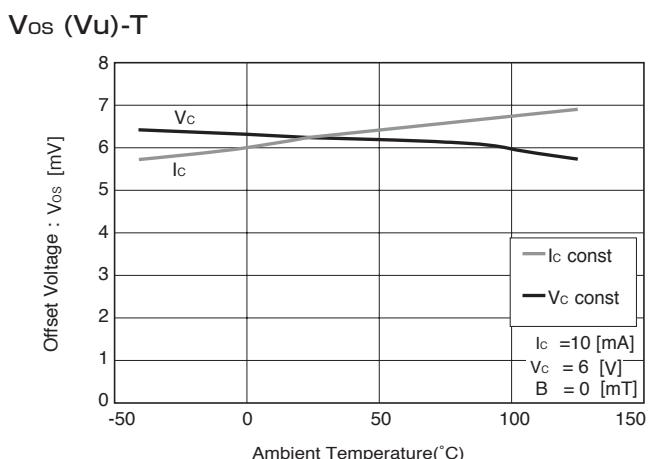
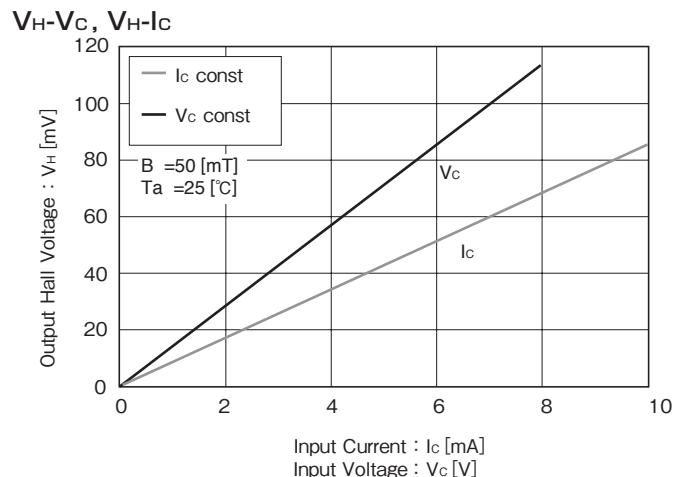
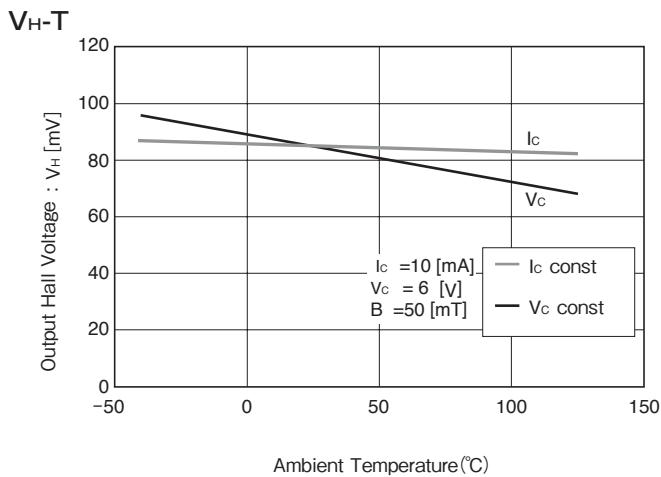
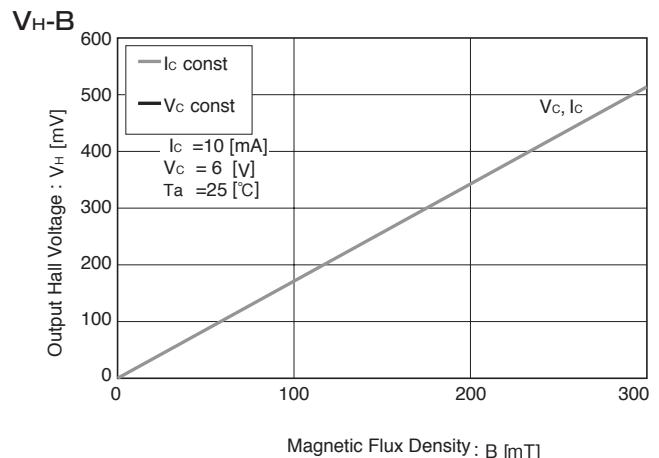
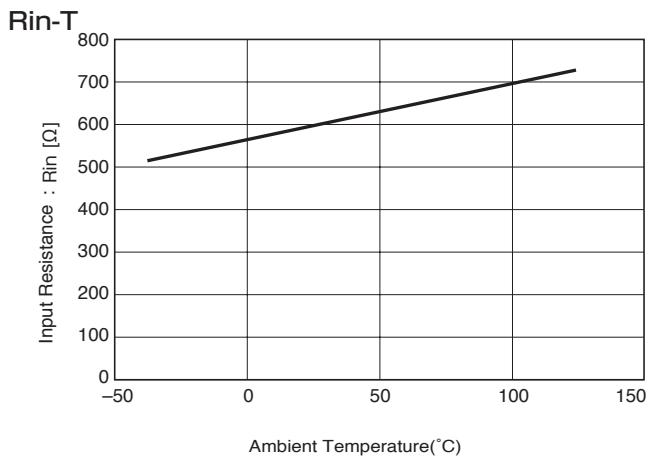


### Characteristic Curves

#### Allowable Package Power Dissipation

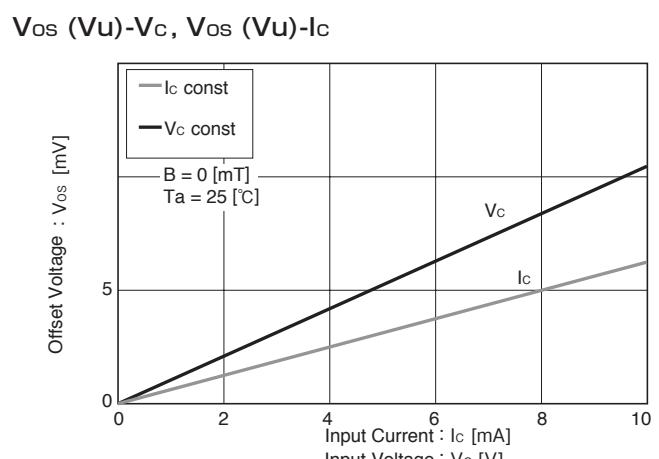


● Characteristic Curves



※Magnetic Flux Density

1[mT]=10 [G]



Rin=750[Ω] , V<sub>os</sub>=0.6 [mV] [V<sub>c</sub>=6 [V]]

In This Example : Rin=750 [Ω] , V<sub>os</sub>=0.6 [mV] , [V<sub>c</sub>=6 [V]]